



Product Change Notification

Change Notification #: 116856 - 00
Change Title: Intel® Dual Band Wireless-AC 3165, SKUs: 3165.NGWG, 3165.NGWG.S, PCN 116856-00, Label, Update Japan Regulatory Marking on Labels
Date of Publication: March 21, 2019

Key Characteristics of the Change:
 Label

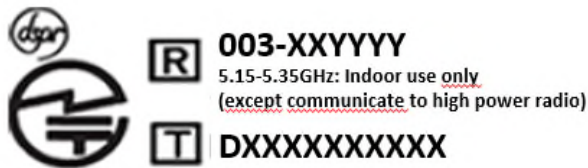
Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	April 12, 2019
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Description of Change to the Customer:

Intel® Dual Band Wireless-AC 3165 SKUs listed in the products affected table below will undergo the following changes.

1. Update Japan Regulatory marking per below.



2. Intel Tracking revision will be changed on the following product.

SKU	Before	After
3165.NGWG	0H	0I

Example Labels

Product Code 3165.NGWG	
Label (Before)	Label (After)
Product Code 3165.NGWG.S	
Label (Before)	Label (After)

Customer Impact of Change and Recommended Action:

The label changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
3165.NGWG	940106	H71304-010	H71304-011
3165.NGWG.S	940107	H72060-008	H72060-009

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
March 21, 2019	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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